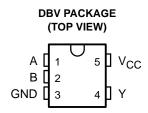
- Operating Range 2-V to 5.5-V V<sub>CC</sub>
- EPIC<sup>™</sup> (Enhanced-Performance Implanted CMOS) Process
- Packaged in Plastic Small-Outline Transistor Package



### description

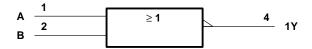
This device contains a single 2-input NOR gate that performs the Boolean function  $Y = \overline{A} \bullet \overline{B}$  or  $Y = \overline{A} + \overline{B}$  in positive logic.

The SN74AHC1G02 is characterized for operation from -40°C to 85°C.

### **FUNCTION TABLE**

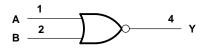
INP	UTS	OUTPUT
Α	В	Y
Н	Х	L
Х	Н	L
L	L	Н

### logic symbol†



<sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

### logic diagram (positive logic)





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### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V <sub>CC</sub>	0.5 V to 7 V
Input voltage range, V <sub>I</sub> (see Note 1)	0.5 V to 7 V
Output voltage range, V <sub>O</sub> (see Note 1)	$\dots$ -0.5 V to V <sub>CC</sub> + 0.5 V
Input clamp current, $I_{ K }(V_{ C } < 0)$	
Output clamp current, I <sub>OK</sub> (V <sub>O</sub> < 0 or V <sub>O</sub> > V <sub>CC</sub> )	±20 mA
Continuous output current, $I_O$ ( $V_O = 0$ to $V_{CC}$ )	±25 mA
Continuous current through V <sub>CC</sub> or GND	
Package thermal impedance, θ <sub>JA</sub> (see Note 2)	347°C/W
Storage temperature range, T <sub>sta</sub>	–65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

### recommended operating conditions (see Note 3)

			MIN	MAX	UNIT
VCC	Supply voltage		2	5.5	V
		V <sub>CC</sub> = 2 V	1.5		
$V_{IH}$	High-level input voltage $ V_{CC} = 3 V $ $ V_{CC} = 5.5 V $	2.1		V	
		V <sub>CC</sub> = 5.5 V	3.85		
		V <sub>CC</sub> = 2 V		0.5	
$V_{IL}$	Low-level input voltage	V <sub>CC</sub> = 3 V		0.9	V
		V <sub>CC</sub> = 5.5 V		1.65	
٧ <sub>I</sub>	Input voltage		0	5.5	V
٧o	Output voltage		0	VCC	V
	High-level output current	V <sub>CC</sub> = 2 V		-50	μΑ
lOH		$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$		-4	mΛ
		$V_{CC} = 5 V \pm 0.5 V$		-8	mA
		V <sub>CC</sub> = 2 V		50	μΑ
lOL	Low-level output current $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$			4	A
		$V_{CC} = 5 V \pm 0.5 V$		8	mA
A+/A	land the position wine our fall mate	V <sub>CC</sub> = 3.3 V ± 0.3 V		100	20/1/
Δt/Δv	Input transition rise or fall rate $V_{CC} = 5 \text{ V} \pm 0$			20	ns/V
TA	Operating free-air temperature		-40	85	°C

NOTE 3: Unused inputs must be held high or low to prevent them from floating.



NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

<sup>2.</sup> The package thermal impedance is calculated in accordance with JESD 51.

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	V	T <sub>A</sub> = 25°C			MIN	MAX	UNIT
PARAMETER	TEST CONDITIONS	vcc	MIN	TYP	MAX	IVIIIV	WAX	UNIT
		2 V	1.9	2		1.9		
	I <sub>OH</sub> = -50 μA	3 V	2.9	3		2.9		
Voн		4.5 V	4.4	4.5		4.4		V
	$I_{OH} = -4 \text{ mA}$	3 V	2.58			2.48		
	$I_{OH} = -8 \text{ mA}$	4.5 V	3.94			3.8		
					0.1		0.1	
	I <sub>OL</sub> = 50 μA	3 V			0.1		0.1	
VOL					0.1		0.1	V
	$I_{OL} = 4 \text{ mA}$	3 V			0.36		0.44	
	$I_{OL} = 8 \text{ mA}$	4.5 V			0.36		0.44	
ΙĮ	$V_I = V_{CC}$ or GND	5.5 V			±0.1		±1	μΑ
l <sub>CC</sub>	$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V			1		10	μΑ
C <sub>i</sub>	$V_I = V_{CC}$ or GND	5 V		4	10		10	pF

# switching characteristics over recommended operating free-air temperature range, $V_{CC}$ = 3.3 V $\pm$ 0.3 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	LOAD	T <sub>A</sub> = 25°C			MIN	MAX	UNIT			
PARAMETER	(INPUT)	(OUTPUT)	CAPACITANCE	MIN	TYP	MAX	IVIIIV	IVIAA	UNIT			
<sup>t</sup> PLH	A D	Y	C: -15 pE		5.6	7.9	1	9.5	20			
t <sub>PHL</sub>	A or B		Y C <sub>L</sub> = 15 pF		5.6	7.9	1	9.5	ns			
t <sub>PLH</sub>	A == D	Y	C: 50 pF		8.1	11.4	1	13				
t <sub>PHL</sub>	A or B		ť	Ť	i Y	YOFB	C <sub>L</sub> = 50 pF		8.1	11.4	1	13

# switching characteristics over recommended operating free-air temperature range, $V_{CC}$ = 5 V $\pm$ 0.5 V (unless otherwise noted) (see Figure 1)

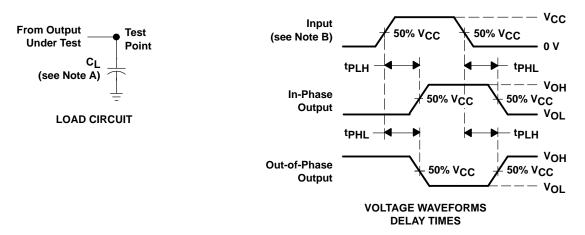
Г	PARAMETER	FROM	FROM TO LOAD (INPUT) CAPACITANCE	LOAD	T <sub>A</sub> = 25°C			MIN	MAX	UNIT	
	PARAMETER	(INPUT)		MIN	TYP	MAX	IVIIIV	IVIAA	UNIT		
	<sup>t</sup> PLH	A or B	V	V .	C: - 15 pF		3.6	5.5	1	6.5	ns
	<sup>t</sup> PHL	AUIB	ī	C <sub>L</sub> = 15 pF		3.6	5.5	1	6.5	115	
	<sup>t</sup> PLH	A or B	Y	C: F0.pF		5.1	7.5	1	8.5	20	
	<sup>t</sup> PHL	AUB		Y	Y C <sub>L</sub> = 50 pF		5.1	7.5	1	8.5	ns

## operating characteristics, $V_{CC} = 5 \text{ V}$ , $T_A = 25^{\circ}\text{C}$

PARAMETER		TEST C	ONDITIONS	TYP	UNIT
C <sub>pd</sub>	Power dissipation capacitance per gate	No load,	f = 1 MHz	15	pF



### PARAMETER MEASUREMENT INFORMATION



NOTES: A.  $C_L$  includes probe and jig capacitance.

- B. Input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz,  $Z_O = 50~\Omega$ ,  $t_f = 3~ns$ ,  $t_f = 3~ns$ .
- C. The output is measured with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



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